U.S. Patent Application No. 10/817,170
Response and Amendment dated February 14, 2008
Reply to Office Action dated August 14, 2007
Attorney Docket No. 022232-9041-01

AMENDMENTS TO THE CLAIMS

This listing of claims replaces all prior versions and listing of claims in the present application:

1. (Currently Amended) A method for forming a heat transfer device for dissipating heat comprising the steps of:

arranging a plurality of fins that are formed with openings that substantially align with one another so as to define a die;

driving a heat pipe comprising a thermally conductive envelope into said die so as to deform said envelope the heat pipe thereby forming at least one flattened surface and wherein an outside shape of said thermally conductive envelope the heat pipe is complementary with said openings; and

supporting said fins upon said thermally conductive envelope the heat pipe such that said thermally conductive envelope the heat pipe substantially defines a mounting base for said heat transfer device, and is attachable to a heat source for thermal energy exchange with said heat source.

2. - 7. (Withdrawn)

- 8. (Currently Amended) The method of claim 1 including forming a collar raised around at least part of said opening prior to driving said thermally conductive envelope the heat pipe.
- 9. (Currently Amended) The method according to claim 1 wherein said fins are substantially exclusively supported by said at least one thermally conductive envelope heat pipe.
- 10. (Currently Amended) The method of claim 1 including changing said outside shape of said heat pipe by driving said thermally conductive envelope the heat pipe on a forming surface defined by said plurality of fins.

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- 11. (Previously Presented) The method of claim 1 wherein arranging a plurality of fins includes forming a stack of spaced-apart fins.
- 12. (Previously Presented) The method of claim 1 including forming the fins from substantially parallel flat sheets.
- 13. (Currently Amended) The method of claim 1 including deforming the thermally conductive envelope heat pipe by contact with the fins.
- 14. (Previously Presented) The method of claim 1 including aligning the openings in the fins to define a channel, and wherein the channel has a reduction in channel width for at least partially defining the outside shape of the heat pipe.
- 15. (Currently Amended) The method of claim 1 including forming the conductive envelope heat pipe to define an oval cross-section having a flattened surface on at least one side.